

TECHNICAL REPORT



**Industrial-process measurement, control and automation – Smart manufacturing –
Part 5: Market and innovation trends analysis**

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CONTENTS

FOREWORD..... 4

INTRODUCTION..... 6

1 Scope..... 7

2 Normative references 7

3 Terms, definitions, abbreviated terms and acronyms 7

 3.1 Terms and definitions..... 8

 3.2 Abbreviated terms and acronyms 9

4 Smart manufacturing trend analysis 11

 4.1 Trend analysis template 11

 4.2 Market watch 12

 4.2.1 General 12

 4.2.2 Mass customization 12

 4.2.3 Value based service along the life of an asset 14

 4.2.4 Artificial intelligence in whatever form of usage 16

 4.2.5 Distribution of analysed information (edge versus cloud) 18

 4.2.6 Collaborative safety (Safety 2.0)..... 25

 4.2.7 Digital factory 29

 4.2.8 Zero-defect manufacturing 30

 4.3 Business model watch 35

 4.3.1 General 35

 4.3.2 Platform business models 35

 4.3.3 Data driven business models 39

 4.3.4 Service-driven and performance-based business models 44

 4.4 Technology watch 45

 4.4.1 General 45

 4.4.2 6G 45

 4.4.3 Quantum computing/networking 48

 4.4.4 AI chipsets/Tools 51

 4.4.5 5G fixed networks 54

 4.4.6 Semantic interoperability 56

5 Summary 63

Bibliography..... 64

Figure 1 – Business context of "Mass customization" 12

Figure 2 – Business context of value-based services for production resources..... 14

Figure 3 – Business context of "Artificial Intelligence" 16

Figure 4 – Digital platforms for the industrial world orchestrate applications across IoT devices, edge, and cloud 18

Figure 5 – Real time risk assessment and control 25

Figure 6 – Digital twin operating in parallel with the physical world 29

Figure 7 – ZDM trend development based on research outcomes 1987-2018..... 31

Figure 8 – Value added processes in platform ecosystems 35

Figure 9 – Value added processes in the context of a brokerage platform 36

Figure 10 – Value added processes in the context of an IIoT platform..... 37

Figure 11 – Value added processes in the context of an edge management system..... 38

| | |
|---|----|
| Figure 12 – Value added processes in the context of a cloud platform | 39 |
| Figure 13 – Potential value from data and analytics | 40 |
| Figure 14 – Data and analytics transformation steps | 41 |
| Figure 15 – Data driven business model – value add (example industry goods) | 42 |
| Figure 16 – 6G Key features | 46 |
| Figure 17 – Heterogeneous network | 46 |
| Figure 18 – AI industrial structure and technology stack | 51 |
| Figure 19 – Overview of AI chip related technologies | 52 |
| Figure 20 – Defining AI, PwC broad definition AI..... | 54 |
| Figure 21 – Evolution of fixed networks..... | 55 |
| Figure 22 – Different levels of interoperability | 56 |
| Figure 23 – Semantic interoperability | 57 |
| Figure 24 – Semantic web Cake..... | 58 |
| Figure 25 – Typical response of traditional companies to unplanned events..... | 59 |
| Figure 26 – Typical response of agile companies to unplanned events..... | 60 |
| Figure 27 – The McKinsey digital compass maps industry 4.0 applications to the 8 main value drivers..... | 61 |
| Figure 28 – Strategic path for future common OT and IT standardization for semantical interoperability | 62 |

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**INDUSTRIAL-PROCESS MEASUREMENT, CONTROL
AND AUTOMATION – SMART MANUFACTURING –****Part 5: Market and innovation trends analysis**

FOREWORD

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IEC TR 63283-5 has been prepared by IEC technical committee 65: Industrial-process measurement, control and automation. It is a Technical Report.

The text of this Technical Report is based on the following documents:

| | |
|-------------|------------------|
| Draft | Report on voting |
| 65/1008/DTR | 65/1028/RVDTR |

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Report is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

A list of all parts in the IEC 63283 series, published under the general title *Industrial-process measurement, control and automation – Smart manufacturing*, can be found on the IEC website

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
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INTRODUCTION

The IEC TR 63283 series describes the framework for smart manufacturing concepts and in particular, terms and definitions, use cases, cyber security, market and innovation trends and new technologies.

This document describes the market and innovation trends and analyses their impediments and impacts to smart manufacturing.

The market trends are based on the tendency that the smart manufacturing markets move into a particular direction potentially using technologies described in other parts of the series. These market trends have the time prospective of 3 years to 5 years to become common smart manufacturing concepts.

The innovation trends describe those technology innovations that are considered to have an impact on or to influence the smart manufacturing concepts. These innovation trends have the time prospective of 5 years to 10 years.

This document also describes how the market and technology trends are influencing the current business models. Some examples of the forthcoming business models are described.

This document has no intention to describe an exhaustive list of market, innovation or the business model trends. It also forecasts how standards will be influenced by these market, innovation and business model trends.

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INDUSTRIAL-PROCESS MEASUREMENT, CONTROL AND AUTOMATION – SMART MANUFACTURING –

Part 5: Market and innovation trends analysis

1 Scope

This part of IEC 63283 describes the market and innovation trends analysis affecting smart manufacturing (SM). The market and innovation trends will influence the evolution of smart manufacturing and it will be important to have good insights on these trends. Specific aspects of the market trends are the evolution of the business cases that is assumed to highlight new supplier chain models, new revenue streams, new customer services, and/or new customer segments.

The document will address the following topics:

- Market watch: Identify the important, likely, and/or disruptive market trends (e.g. mass customization) from an end-to-end perspective, which impact smart manufacturing topics/aspects. This includes the end-user, producers, supply chain, regulators, etc.
- Business model watch: Identify the new business model trends from an end-to-end perspective, which impact smart manufacturing.
- Technological watch: Identify the important, likely, and/or disruptive innovations (AI chipsets, 6G, quantum computing, etc.) describing the impacted smart manufacturing topics/aspects; this topic will focus on those technologies that are still under development but is assumed to influence (or is assumed to be influenced by) smart manufacturing.

There are many more new trends which are used in SM. In this document, only some frequently discussed trends are presented. Some technologies are considered to have priority according to their maturity.

This work will focus on how they can be used in SM.

2 Normative references

There are no normative references in this document.

3 Terms, definitions, abbreviated terms and acronyms

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- IEC Electropedia: available at <https://www.electropedia.org/>
- ISO Online browsing platform: available at <https://www.iso.org/obp>

NOTE Numbers in square brackets refer to the Bibliography.

3.1 Terms and definitions

3.1.1

market trend

perceived tendency of a particular sector to move in a particular direction over time

Note 1 to entry: These trends are classified as secular for long time frames, primary for medium time frames, and secondary for short time frames.

Note 2 to entry: This report attempts to identify market trends using technical analysis, a framework which characterizes market trends as predictable tendencies within the market when the trend reaches support and resistance levels, varying over time.

Note 3 to entry: A trend can only be confirmed in hindsight, since at any time the future is not known.

Note 4 to entry: In this document, market trend also includes tendency of technology innovations and behaviour of the stakeholders around such innovations.

3.1.2

innovation

new idea, creative thoughts, new imaginations in form of device or method

Note 1 to entry: Innovation is often also viewed as the application of better solutions that meet new requirements, unarticulated needs, or existing market needs. Such innovation takes place through the provision of more-effective products, processes, services, technologies, or business models that are made available to markets, governments and society.

Note 2 to entry: An innovation is something original and more effective and, as a consequence, new, that "breaks into" the market or society. Innovation is related to, but not the same as, invention, as innovation is more apt to involve the practical implementation of an invention (i.e. new/improved ability) to make a meaningful impact in the market or society and not all innovations require an invention. Innovation often manifests itself via the engineering process, when the problem being solved is of a technical or scientific nature.

Note 3 to entry: While a novel device is often described as an innovation, in economics, management science, and other fields of practice and analysis, innovation is generally considered to be the result of a process that brings together various novel ideas in such a way that they affect society. In industrial economics, innovations are created and found empirically from services to meet growing consumer demand.

[SOURCE: Wikipedia article on Innovation, <https://en.wikipedia.org/wiki/Innovation>. This work is licensed under the Creative Commons Attribution-ShareAlike 4.0 International License. To view a copy of this license, visit <http://creativecommons.org/licenses/by-sa/4.0/>]

3.1.3

innovation trend

assumed innovation in the future that will have a long-term and lasting effect on and change something

EXAMPLE Current developments are moving in a different direction or intensifying even more.

3.1.4

zero-defect manufacturing

ZDM

holistic approach for ensuring both process and product quality by reducing defects

Note 1 to entry: Defect reduction is achieved through corrective, preventive and predictive techniques using mainly data-driven technologies and guaranteeing that no defective products leave the production site and reach the customer aiming at higher manufacturing sustainability.

Note 2 to entry: ZDM improves process efficiency and product quality.

3.1.5

asset

entity owned by or under the custodial duties of an organization, which has either a perceived or actual value to the organization

[SOURCE: IEC TR 63283-1:2022 [1], 3.1.26]

3.1.6**production system**

system intended for production of goods

Note 1 to entry: The concept of production system includes spare parts.

Note 2 to entry: The concept of production system does not encompass the whole manufacturing facility. It excludes in particular the supporting infrastructure (such as building, power distribution, lighting, ventilation). It also excludes financial assets, human resources, raw process materials, energy, work pieces in process, end products.

Note 3 to entry: Production systems can support different types of production processes (continuous, batch, or discrete).

[SOURCE: IEC TR 63283-1:2022 [1], 3.1.350]

3.2 Abbreviated terms and acronyms

| | |
|--------|---|
| 4G | 4 th generation cellular system |
| 5G | 5 th generation cellular system |
| 5G-PPP | 5 th Generation – Public Private Partnership |
| 6G | 6 th generation cellular system |
| 6G-PPP | 6 th Generation – Public Private Partnership |
| AAS | asset administration shell |
| ADSL | asymmetric digital subscriber line |
| AI | artificial intelligence |
| AIOTI | Alliance for the Internet of Things Innovation |
| API | application programming interface |
| App | application |
| B2B | business to business |
| B2C | business to consumer |
| BIS | building information system |
| CAD | computer aided design |
| CAM | computer aided manufacturing |
| CCPA | California Consumer Privacy Act |
| CDD | common data dictionary |
| CPU | central processing unit |
| CSA | coordination and support action |
| CWA | CEN Workshop Agreement |
| DevOps | SW development and IT operations |
| DF | digital factory |
| DMP | digital manufacturing platform |
| DSP | digital signal processor |
| E/W | East/West |
| ECN | edge control node |
| EPON | Ethernet Passive Optical Network |
| ERP | enterprise resource planning |

| | |
|---------|--|
| EU-OSHA | European Agency for Safety & Health at Work |
| F6G | 6 th generation fixed network |
| FCC | Federal Communications Commission |
| GDPR | General Data Protection Regulation |
| GHz | giga hertz |
| GPON | gigabit passive optical network |
| GPU | graphics processor unit |
| HAP | high-altitude platform |
| HPC | high performance computing |
| I4.0 | Industry 4.0 |
| IACS | industrial automation and control systems |
| ICT | information communication technology |
| IEEE | Institute of Electrical and Electronics Engineers |
| IETF | Internet Engineering Task Force |
| IIoT | industrial Internet of things |
| IoT | Internet of things |
| ISDN | Integrated Services Digital Network |
| ISP | image signal processor |
| IT | information technology |
| ITU-T | International Telecommunication Union – Telecommunication Standardization Sector |
| LCA | life cycle assessment |
| LGPD | Lei Geral de Proteção de Dados or General Data Protection Law |
| LTE | long term evolution |
| M2M | machine to machine |
| MES | manufacturing execution system |
| MIIT | China Ministry of Industry and Information Technology |
| MIMO | multiple input multiple output |
| ML | machine learning |
| mmWave | millimeter wave |
| MQTT | Message Queuing Telemetry Transport |
| N/S | North/South |
| NB-IoT | narrowband – Internet of things |
| NISQ | noisy intermediate-scale quantum |
| O&M | operations and maintenance |
| OCI | open container initiative |
| oneM2M | Standards for M2M and the Internet of Things |
| OPC | Open Platform Communications |
| OPC-UA | OPC Unified Architecture |
| OPE | operational excellence |
| OPEX | operational expenses |
| OS | operating system |
| OTD | open technical dictionary |

| | |
|--------|--|
| OWL | web ontology language |
| PC | personal computer |
| PON | passive optical network |
| PSTN | public switched telephone network |
| QKD | quantum key distribution |
| QoS | quality of service |
| Qubits | quantum bits |
| RDF | resource description framework |
| R&D | research and development |
| SaaS | software as a service |
| SG | study group |
| SM | smart manufacturing |
| SME | small medium enterprise |
| SW | software |
| TCG | Trust Computing Group |
| THz | tera hertz |
| TRL | technology readiness level |
| TSN | Time Sensitive Networking |
| VDSL | very high-speed digital subscriber line |
| WFA | Wi-Fi Alliance |
| WIA-PA | Wireless Networks for Industrial Automation/Process Automation |
| Wi-Fi | Wireless Fidelity |
| XML | eXtended Markup Language |
| ZDM | Zero-Defect Manufacturing |

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4 Smart manufacturing trend analysis

4.1 Trend analysis template

Each trend is described by the following template introducing the following aspects of the trend:

- Description

This subclause describes the trend textually, how the trend is used in reality (use case), and the stakeholders in order to clarify the referenced market, market expectations, business model or the technology trend.

- Impediments to market acceptance

This subclause describes what the market obstacles are to realise the market trends, e.g. restrictions, uncertainty, competitive technologies, regulatory restrictions.

- Impacts to smart manufacturing

This subclause analyses the trend and describes the impacts to smart manufacturing. Potential impacts, if addressed, could be specified to the smart manufacturing use cases, architecture, information models, lifecycle, interfaces, security and safety.

- Standardization needs

This subclause describes the standardization needs internally and externally of IEC TC 65. If there are standardization needs identified for IEC TC 65, then the suggested respective working group and/or subcommittee are identified where such standardization ought to take place.

4.2 Market watch

4.2.1 General

Some of the common smart manufacturing market trends are listed within the following subclauses. They are based on the technologies as described in other parts of this series, which describe new innovative technologies expected in the coming years. It is understood that these innovative technologies are already available and have been proven useful to the domain of smart manufacturing. Therefore, the required technologies are ready to realise the described market trends below and it is assumed that these market trends will be common within smart manufacturing in 3 years to 5 years.

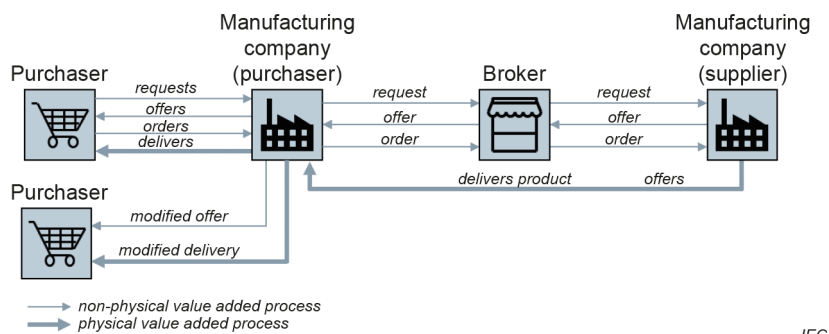
What is being described is not intended to produce an exhaustive list of market trends.

4.2.2 Mass customization

4.2.2.1 Description

The customer demands have evolved from standard mass market products towards personalised products based on the customer needs. This market trend can be realised by benefiting from the capabilities that smart manufacturing provides, like the flexible production systems.

The manufacturing market is evolving towards an individualised market that will require a manufacturing company to offer a flexible product/service portfolio. Therefore, a manufacturing company will require a strategy addressing such individualised market, while still being profitable from its operational perspective. Examples of such strategies are Manufacturing of Individualised Products, Flexible Scheduling and Resource Allocation and Outsourcing of Production, collectively named order-controlled production. Figure 1 illustrates a combined business context of the separate business contexts of Manufacturing of Individualised Products, Flexible Scheduling and Resource Allocation and Outsourcing of Production, which are further explained within IEC TR 63283-2 [2]¹.



SOURCE: IEC TR 63283-2:2022, modified combining use cases 6.1.1, 6.1.2 and 6.1.3 (Figures 6, 8, and 10).

Figure 1 – Business context of "Mass customization"

¹ Numbers in square brackets refer to the Bibliography.